

# SPECIFICATION FOR TFT MODULE

**MODULE NO.: IPS070A108S** 

Rev No.: O

GTK	PREPARED BY	CHECKED BY	APPROVED BY
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DATE	2021.03.16	2021.03.16	2021.03.16

DATE	SIGNATURE	
		CUSTOMER APPROVAL

## Notes:

- 1. Please contact GTK before assigning your product based on this module specification.
- 2. To improve the quality of product, and this product specification is subject to change without any notice.

# **REVISION RECORD**

Rev No.	Rev date	Contents	Remarks
0	2021-03-16	First release	Preliminary
	l		

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# 1. GENERAL INFORMATION

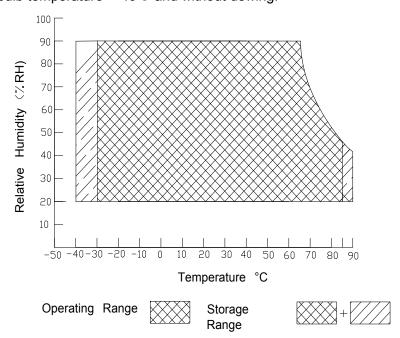
No.	Item	Contents	Unit
1	LCD size	7.0 inch (Diagonal)	1
2	Display mode	IPS/Normally black/Transmissive/Anti-glare	1
3	Viewing direction(eye)	Free	/
4	Gray scale inversion direction	-	/
5	Resolution(H*V)	800 *480 Pixels	1
6	Module size (L*W*H)	166.60*109.40*5.62	mm
7	Active area (L*W)	152.40*91.44	mm
8	Pixel pitch (L*W)	0.1905*0.1905	mm
9	Interface type	RGB 24bit interface	1
10	Color Depth	16.7M	1
11	Module power consumption	TBD	W
12	Back light type	LED	/
13	Driver IC	NT51629+NT52601 OR COMPATIBLE	1
14	Weight	TBD	G

## 2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min.	Max.	Unit	Note
Power supply input voltage for TFT	VDD	-0.3	5.0	V	
Backlight current (normal temp.)	ILED	-	325	mA	
Operation temperature	Тор	-30	+85	°C	Note1
Storage temperature	Tst	-40	+90	°C	Note1
Humidity	RH	20%	90%	RH	Note1

## Note1:

- 1). The relative humidity and temperature range are as below sketch, 90%RH Max.
- 2). The maximum wet bulb temperature  $\leq 40^{\circ}$ C and without dewing.



# 3. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS(at Ta=25°C)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Power supply input voltage for TFT	VDD	2.7	3.3	3.6	V	
Input voltage 'H' level	VIH	0.7VDDIO	-	VDDIO	V	
Input voltage 'L' level	VIL	VSS	-	0.3VDDIO	V	
Power supply current	IVDD	-	TBD	-	mA	

## 4. BACKLIGHT CHARACTERISTICS

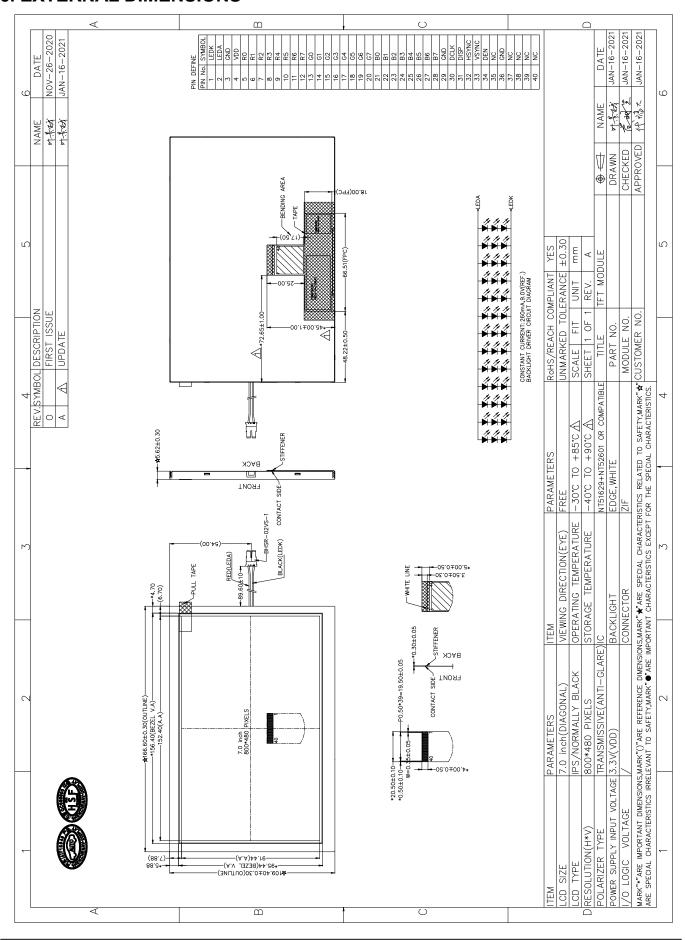
(at Ta=25°C,RH=60%)

(40 14 20 0)141 00 (0)						
Item	Symbol	Min.	Тур.	Max.	Unit	Note
LED forward voltage	VF	8.4	9.0	9.9	V	
LED forward current	IF	-	260	-	mA	IF=20*13mA
LED power consumption	PLED	-	2.34	-	W	Note1
Number of LED	-		39		PCS	
Connection mode	-	3 in series 13 in parallel			1	
LED life-time	-	20000	-	-	Hrs	Note2

Note1 : Calculator value for reference : IF\*VF = PLED

Note2: The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =260mA. The LED lifetime could be decreased if operating IF is larger than 260mA.

## **5. EXTERNAL DIMENSIONS**



## 6. ELECTRO - OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark	Note	
Response time	Tr+ Tf		-	25	35	ms	FIG.1	Note 1	
Contrast ratio	Cr	-	640	800	-	-	FIG.2	Note 2	
Surface luminance	Lv	θ=0°	500	650	-	cd/m <sup>2</sup>	FIG.2	Note 3	
Luminance uniformity	Yu	θ=0°	75	80	-	%	FIG.2	Note 4	
NTSC	-	θ=0°	-	50	-	%	FIG.2	Note 5	
		Ø=90°	80		-	deg	FIG.3		
Viouring angle	0	Ø=270°	80		-	deg	FIG.3	Note 6	
Viewing angle	θ	Ө	∅=0°	80		-	deg	FIG.3	Note 6
		Ø=180°	80		-	deg	FIG.3		
	Red x			TBD		-			
	Red y			TBD		-			
	Green x			TBD		-	FIG.2	Note 5	
CIE (x,y)	Green y	θ=0°	Тур	TBD	Тур	-			
chromaticity	Blue x	Ø=0° Ta=25°C	-0.04	TBD	+0.04	-	CIE1931		
	Blue y	10-20 0		TBD		-			
	White x			TBD		-			
	White y			TBD		-			

#### Note1. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time  $(T_{ON})$  is the time between photo detector output intensity changed from 90% to 10%. And fall time  $(T_{OFF})$  is the time between photo detector output intensity changed from 10% to 90%. For additional information see FIG1.

#### Note2. Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula.

For more information see FIG.2.

Contrast ratio= Luminance measured when LCD on the "White" state Luminance measured when LCD on the "Black" state

Measured at the center area of the LCD

#### Note3.Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white.

For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3, .....,Pn)

#### **Note4.Definition of luminance uniformity**

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.2.

 $Y_{11} = \frac{\text{Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}{\text{Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}$ 

Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)

#### Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity,The x,y value is determined by screen active area center position P5.For more information see FIG.2.

#### Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE,the testing data is base on TOPCON's BM-5or BM-7 photo detector or compatible.

FIG.1. The definition of response Time

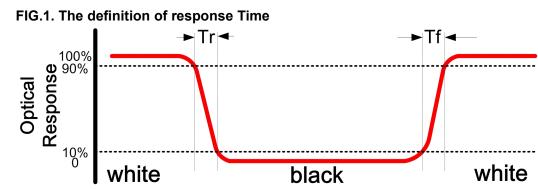


FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

H,V: Active area

Light spot size  $\emptyset$  = 5 mm(BM-5) or  $\emptyset$  =7.7mm (BM-7)50cm distance or compatible distance from the LCM surface to detector lens.

Test spot position : see Figure a.

measurement instrument: TOPCON's luminance meter BM-5 or BM-7 or compatible, see Figure b.

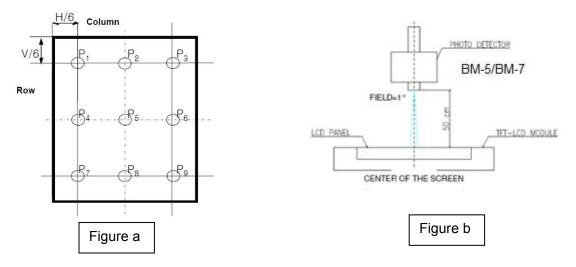
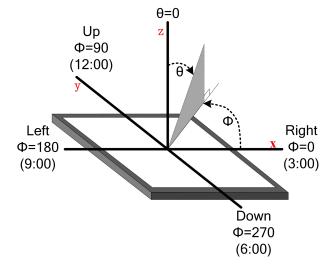


FIG.3. The definition of viewing angle



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# 7. INTERFACE DESCRIPTION

**Module Interface description** 

Interface No.	Name	I/O or connect to	Description
1	LEDK	Р	Not connect
2	LEDA	Р	Not connect
3	GND	Р	Ground
4	VDD	Р	Power for LCD
5-12	Red(0-7)	I	Red data
13-20	Green(0-7)	I	Green data
21-28	Blue(0-7)	I	Blue data
29	GND	I	Ground
30	DCLK	I	Dot clock
31	DISP	I	Display on/off
32	HSYNC	I	Horizontal sync input.
33	VSYNC	I	Vertical sync input
34	DEN	I	Data enable
35	NC	1	1
36	GND	Р	Power ground
37	NC	1	1
38	NC	1	1
39	NC		1
40	NC	1	1

# **8.AC CHARACTERISTICS**

(VDD\_IF=VDD= 2.7V to 3.6V, VDDA= 8V to 13.5V, GND\_IF=GND=GNDA= 0V, T<sub>J</sub>=-40°C to +105°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Clock Frequency	Fclk	5	-	55	MHz	Tclk = 1/Fclk
CLK pulse width	Tcw	30% (*)	-	70%	TCLK	(*) Over than 0.5/(Fclk)max.
HS setup time	Thsu	6	-	-	ns	2
HS hold time	Тнно	6	-	-	ns	
VS setup time	Tvsu	6	107	15	ns	
VS hold time	TVHD	6	-	-	ns	
Data setup time	Tosu	6	-	-	ns	~ //
Data hold time	TDHD	6	-	-	ns	11 1/1 1/2
DE setup time	TESU	6	-	-	ns	755

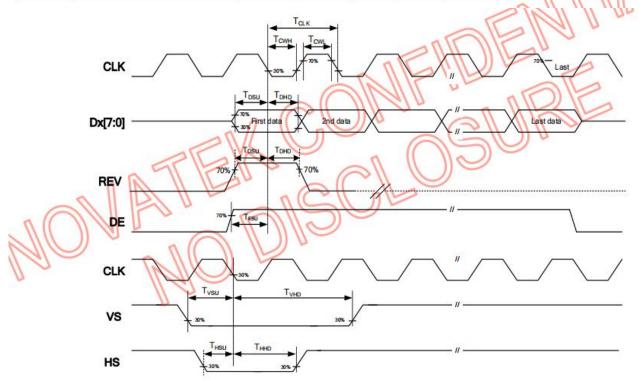
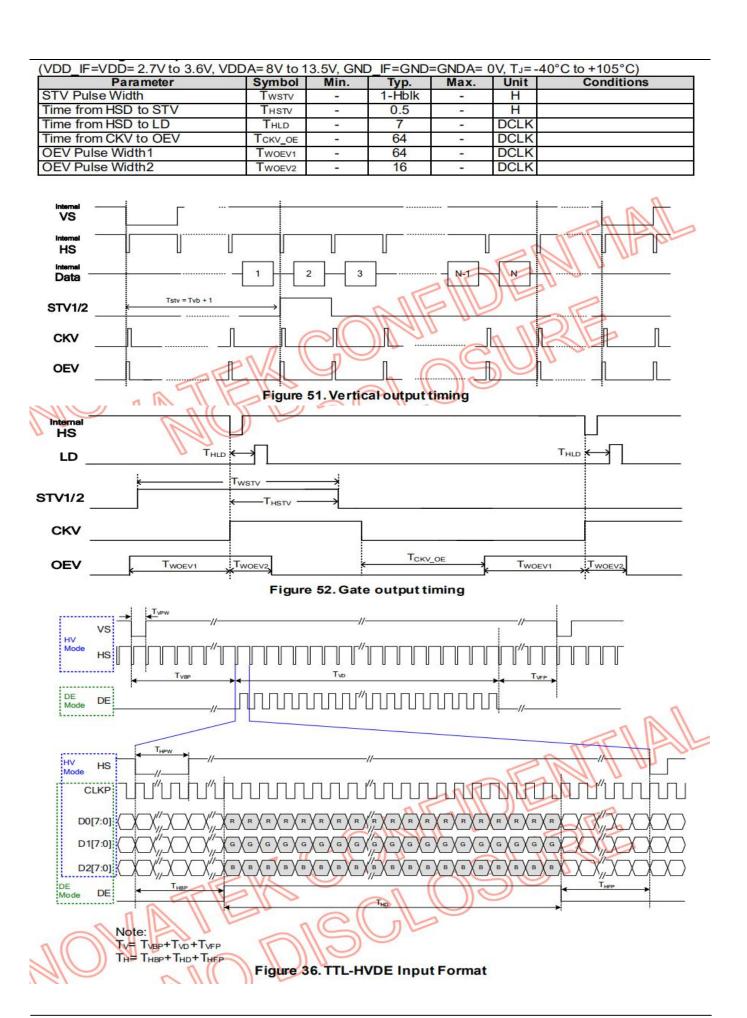


Figure 46. TTL-HVDE Interface Timing



Parameter	Symbol	Min.	Тур.	Max.	Unit
CLK frequency	Fclk	25.2	25.4	35.7	MHz
Horizontal display area	THD		800		CLK
HS period time	Тн	860	864	974	CLK
HS pulse width	THPW	1	2	< THBP	CLK
HS back porch	Тнвр		32	Heren	CLK
HS front porch	THEP	28	32	142	CLK
Vertical display area	TvD	0	480	101	Н
VS period time	Tv	488	490	611	Н
VS pulse width	Tvpw	1	2	< Tvbp	Н
VS back porch	TVBP		5		(선 //
VS front porch	TVFP	3	5	126	11 PM 11
Table 27. DE mode for 800x		Pai 105	27 29	n-	11 11 - 17
Parameter	Symbol	Min.	Тур.	Max.	Unit
CLK frequency	Fclk	25.2	25.4	35.7	MHz
Horizontal display area	THD		800	1	CLK
HS period time	Тн	860 , (	864	974	CLK
HS blanking	THEP + THEP	60 \\	64	174	CLK
Vertical display area	TvD	<b>MIM</b>	480		H
VS period time	Tv	488	490	\611	Н
VS blanking	TVBP + TVFP	8	10	131	Н

## 9. POWER SEQUENCE

# To prevent the device damage from latch up and Improve subjective display effect, the power ON/OFF sequence shown below must be followed.

This IC is a HIGH-voltage LCD driver and may be damaged by a large current flow when an incorrect power sequence is applied. The recommended sequence should be: Digital power(VDD, GND) → Logic signals→ Analog power(VDDA, GNDA) & Gamma correction reference voltage(GMAH, GMAL). To shut down, reverse this sequence, or turn off all signals and power simultaneously.

In order to prevent IC from power on reset fail, the rising time (T POR) of the digital power supply VDD should be maintained within the given specification. Refer to "AC Characteristics" for more detail on timing.

It takes 3 VS for EEPROM to finish READ operation during power on sequence.

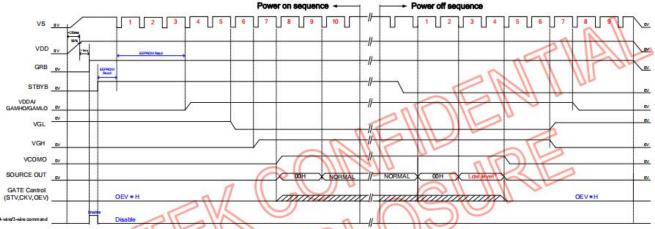


Figure 27. Power On/Off Timing with EEPROM

Note: LOW level = low voltage applied to LC cell.

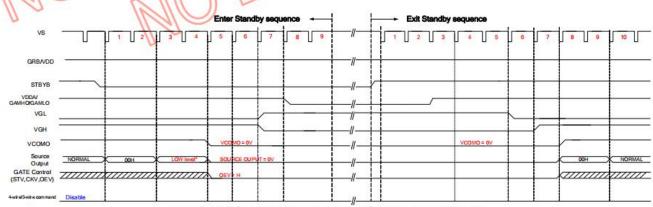


Figure 28. Enter/Exit Standby Mode with EEPROM

Note: LOW level = low voltage applied to LC cell.

## **10. RELIABILITY TEST CONDITIONS**

No.	Test item	Test con	Inspection after test		
11.1	High temperature storage test	+90°C/240 hours			
11.2	Low temperature storage test	-40°C/240 hours			
11.3	High temperature operating test	+85°C/120 hours			
11.4	Low temperature operating test	-30°C/120 hours		Inspection after	
11.5	Temperature cycle storage test	-40°C ~ 25°C ~ +90° (30min.) (10min.) (30	2~4hours storage at room temperature, the		
11.6	High temperature high humidity test	+50°C*90% RH/120	sample shall be free from defects : 1.Current changing		
11.7	Vibration test	Frequency : 250 r/mi Amplitude : 1 inch Time: 45min			
		Drop direction: 1 corner/3 edges/6 s	ides 10 times	Non-display,abnormal-d isplay,missing lines, Short lines,ITO	
		Packing weight(kg)	Drop height(cm)	corrosion;	
11.8	Drop test	<11	80±1.6	3.Visual defect : Air bubble in the LCD,Seal	
		11≦G<21	60±1.2	leak,Glass crack.	
		21≦G<31	50±1.0		
		31 ≦ G<40 40±0.8			
11.9	ESD test	Air discharge: ±8KV, Contact discharge: ±			

#### Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 3~5pcs.
- 3. For High temperature high humidity test, Pure water(Resistance>10M $\Omega$ ) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5.B/L evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence B/L has.
- 6. Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic.
- 7.After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

## 11.INSPECTION CRITERION

Refer to 《Inspection Criterion for TFT Products-To customer》 V2.3, DOCUMENT NO.: IPS070A108A

#### 12. HANDLING PRECAUTIONS

## 12.1 Mounting method

The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

## 12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly:

- .lsopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- .Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- •.Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

#### 12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you :

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

#### 12.4 Packing

Module employ LCD elements and must be treated as such.

- Avoid intense shock and falls from a height.
- •. To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

#### 12.5 Caution for operation

- •.It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- •.An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- •.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- •. If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- •.A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
- •. Usage under the maximum operating temperature, 50%Rh or less is required.
- •. When fixed patterns are displayed for a long time, remnant image is likely to occur.

#### 12.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- •. Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.
- •. Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- •. Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature

range.

• .Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

#### 12.7 Safety

- •.It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- •. When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

#### 13. PRECAUTION FOR USE

- **13.1** A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.
- **13.2** On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.
- When a question is arisen in this specification.
- •. When a new problem is arisen which is not specified in this specifications.
- •. When an inspection specifications change or operating condition change in customer is reported to GTK, and some problem is arisen in this specification due to the change.
- •. When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

#### 14. PACKING SPECIFICATION

Please consult our technical department for detail information.

#### 15. INITIALIZATION CODE

TBD

### 16. HSF COMPLIANCE

•.This products complies with ROHS 2011/65/EU and 2015/863/EU 、REACH 1907/2006/EC requirements, and the packaging complies with 94-62-EC.

		Doc. Name	Inspection Criterion for TFT Products	Ver.	V2.3
Doc. Level	Class 3	Doc. No.	IPS070A108A	Page	Page 2 of 10

## 1. Objective

The TFT test criterion are set to formalize TFT quality standards for GTK with reference to those of the customer for inspection, release and acceptance of finished TFT products in order to guarantee the quality of TFT products required by the customer.

## 2. Scope

The criterion is applicable to all the TFT products manufactured by GTK.

## 3. Equipment for Inspection

Electrical tester, electrical testing machines, vernier calipers, microscopes, magnifiers, anti-static wrist straps, finger cots, labels, tri-phase cold and hot shock machine, constant temperature and humidity chamber, backlight table, ovens for high-low temperature experiments, refrigerators, constant voltage power supply (DC) )), desk Lamps, etc.

## 4. Sampling Plan and Reference Standards

#### 4.1.1 Sampling plan:

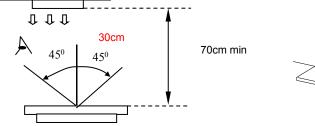
Refer to National Standard GB/T 2828.1---2012/ISO2859-1:1999, level II of normal levels:

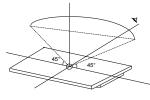
Product	Automobile
Category	Automobile
AQL	MA=0.15 MI=0.40

- 4.1.2 GB/T 2828.1---2012/ISO2859-1:1999 Sampling check procedure in count
- 4.1.3 GB/T 18910. Standard for LCM parts
- 4.1.4 GB/T24213-2008 Basic Environmental Test Procedures for Electrical and Electronic Products
- 4.1.5 IPC-A-610E Acceptability of Electronic Assemblies

## 5. Inspection Conditions and Inspection Reference

- 5.1Cosmetic inspection: shall be done normally at  $23\pm5^{\circ}$ C of the ambient temperature and 45~75%RH of relative humidity, under the ambient luminance between 500lux~1000lux and at the distance of 30cm apart between the inspector's eyes and the LCD panel and normally in reflected light. For backlight LCM, cosmetic inspection shall be done under the ambient luminance less than 100lux with the backlight on.
- 5.2 The TFT shall be tested at the angle of 45°left and right and 0-45° top and bottom as the following picture showing:





5.3 Definition of viewing area (VA)

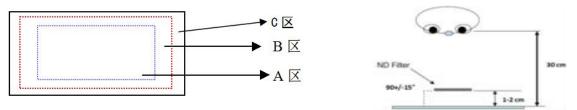
A area: Active area (AA area) B area: Viewing area (VA area)

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C area: Non-viewing area (not viewing after customer assembly)

If there is any appearance viewing defect which do not affect product quality and customer assembly in C area, it's accepted in generally.

The criteria apply to A and B area except chipping and crack.



- 5.4 Inspection with naked eyes(exclusive of the inspection of the physical dimensions of defects carried out with magnifiers)
- 5.5 ND card use method(refer to right conner image) and scope: Multi-bright dot; Mura(Black/Gray pattern uneven); dark line and so on.
- 5.6 Undefined items or other special items, refer to mutual agreement and limited sample. If criterion does not match product specifications/ technical requirement, both should be subject to special inspection criterion agreed by customer.

## 6. Defects and Acceptance Standards

- 6.1 Electrical properties test
- 6.1.1 Test voltage(V): Refer to the instruction of testers and the product specification or drawing and the display content and parameters and display effects shall conform to the product specification and drawing.
- 6.1.2 Current Consumption(I): Refer to approved product specifications or drawings.
- 6.1.3 Function items(Defect category MA)

No.	Defects	Descriptions	Pictures	Inspection method/tools	Defect category
6.1.3.1	No display /reaction	shows no picture/display in normal connected situation.		Naked eyes/ testers	MA
6.1.3.2	Missing segment	Shows missing lines in normal display		Naked eyes/ testers	MA
6.1.3.3	Dark line	Only visible on gray pattern, 1 or more vertical/horizontal lines: 5%ND, not visible, OK	/	Naked eyes/ testers	MA
6.1.3.4	POL angle defect	Not accepted	正常 POL斯反180座后	Naked eyes/ testers	MA
6.1.3.5	Flicker	Refer to Limit sample if essential or flicker value <-30dB (measured by CA310A); OK		Naked eyes/ CA310A	МА

				Doc. Name	Inspection Cri for TFT Prod		Ver.	V2.3
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6.1.3.6	Display Not accepted abnormal					Nake teste	d eyes/ rs	MA
6.1.3.7	Cross-ta	ılk	Refer to limited	l sample	+		d eyes/ d sample	MA
6.1.3.8	Display dim/brig	ht	Refer to limited	l sample	/		d eyes/ d sample	MA
6.1.3.9	Contras	t	Refer to limited	l sample	/		d eyes/ d sample	MA
6.1.3.10	Huge current		Out of spec, no	ot accepted	/	/ Ammeter		MA
6.1.3.11 TP function defect Not accepted			Not accepted		/	Touc	d eyes/ h/ program	MA

## 6.2 LCD dot/line defect

## 6.2.1 LCD pixel dot defect(defect category: MI)

Item	Inspection criterion								
Size	S <5"	5≤S<10"	10≤S<15"	<u>S≥15"</u>					
Color pixel dot defect(RGB dot)	1	2	2	3					
2 connected bright dot	0	1	1	1					
3 connected bright dot or more	0	0	1	<u>0</u>					
Bright dot quantity	1	2	3	<u>4</u>					
Random dark dot quantity	2	3	4	<u>5</u>					
2 connected dark dot	1	1	2	2					
3 connected dark dot or more	0	0	0	<u>0</u>					
Dark dot quantity	3	4	5	<u>6</u>					
Multi-bright dot	ND 5% hidden, OK								

Remark: 2 bright dots distance DS≥15mm 2 dark dots distance DS≥5mm

- 1) Bright dot: Power on TFT and RGB dot in black display
- 2) Dark dot: Power on TFT and gray or black dot in RGB display
- 3) Multi-bright dot: Power on TFT and fluorescent tiny dot in black display(only visible in black display)

## 6.2.2 LCD appearance dot defect (defect category: MI)

Inspection criterion							Picture	Inspection
No.	Item	Size	S ~5"	5≤S<10"	10≤S<	S≥15"		method/tool
		Size	3 \3	3 <u>2</u> 3~10	15"	<u>3213</u>		s

					Doc. lame			•		n Criter Produc		Ver.		V2.3
Doc.	Level	Class 3		Do	c. No.		AIPS	070A	.108	BA		Page		Page 5 of 10
		D≤0.15	ignore	)	ignor	е	D≤0	.2;	D<	<u>≤0.2;</u>				
		0.15< D≤0.25	3		3		Not count		ignore			\$ b	N	aked eyes
	Dot defec	0.25< b	1		2		0.2~0	.35	0.2	~0.35	D=	=(a+b)/2		ilm card nagnifier
6.2.2.1	(black dot white dot)	0.30<	0		1		Q'ty ≤	≦4	Q'ty	<u>/ ≤ 5</u>				
	Write dot)	0.35< D≤0.50	0		0		1		2					
	D		0		0		0		0					
		Remark: Count do										•	as	multi-dot.
		Length	Width		<b>∠</b> Γ"	<u>5≤S</u>	<u>s&lt;</u>	<u>10≤S</u>	<u> </u>	0>45"				
		(mm)	(mm)	5	<u>&lt;5"</u>	<u>10"</u>		<u>15"</u>		<u>S≥15"</u>				
	Line defec	Not count	W≤0.03	3 Igi	nored	Ign	ored	Ignoi	red	Ignored	<u>d</u>			
		L≤5	0.03≤V <0.05	3		3		Ignoi	red	Ignored			W	Naked eyes
6.2.2.2		L≤5	0.05≤V <0.08	<u>V</u> 0	1	1		3		3	*	<b>\</b>		/film card /magnifier
	when power on)	) L≤8	0.05≤V <0.08	<u>V</u> 0	ı	0		1		2				
		L>8	<u>W&gt;</u> 0.08	0		0		0		<u>0</u>				
		Remark: as water keeping	mark/fold		•					•				light, show er to
		Size(mr	m s <5'	-	<u>5≤S</u> <	10"	<u>10≤9</u>	<u>s&lt;</u>	<u>S≥</u>	<u>15"</u>				
	Polarizer	<u>D≤0.20</u>	Ignore	d	Ignore	ed	Igno	red	<u>lo</u>	<u>inored</u>		\$ b		
6.2.2.3	convex- concave	<u>0.20</u> < <u>D≤0.5</u>	2		2		3		<u>5</u>		→ a	<del>, •</del>	Na	aked eyes
	dot defect polarizer	t, <u>0.50&lt;</u> <u>D≤0.8</u>	0		1		2		3					m card agnifier
	bubble defect		0		0		1		2					
		<u>D&gt;</u> 1.5mm	0		0		0		<u>0</u>					

# 6.3 Chipping defect

No. It	Item	Accepted criterion(mm)	MAJ	MIN	
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					oc. ime		Inspection C for TFT Pro		Ve	r.	V2	.3
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	ITO con	ductive side	Х		1		≤1/8L	1				
6.3.1		Z	Υ		Y≤1/6	sW	1/6W <y≤1 4w<="" td=""><td>1/4W &lt;</td><td>Υ</td><td></td><td></td><td>1</td></y≤1>	1/4W <	Υ			1
	×	× ×	Aco	ccept 2			2	0				
6.3.2	Cor	ner chipping	X	X /			≤1/6L	1				
		s position)	Y	Y≤1/2		:W	1/2W <y≤w< td=""><td>W <y< td=""><td></td><td></td><td></td><td>√</td></y<></td></y≤w<>	W <y< td=""><td></td><td></td><td></td><td>√</td></y<>				√
			Aco	Accept 2 1 0								
	2 :	T	as into chi per	Corner chipping occurred in sealed edge position as per 6.3.3; at the same time it should not enter into black border of the frame and the corner chipping effect the electric connection position perform as per 6.3.1.								
		g in sealed	X		/		≤1/8L	/				
	area (ot	utside chipping)	Y (outside chipping)		) No	t enter	Enter Y≤H	H <y< td=""><td></td><td></td><td></td><td></td></y<>				
633	z ‡		`	side pping	sea	alant	Enter Y≤1/2H	1/2H<	Υ			2
6.3.3		12	Z		≤T		≤1/2T	1				\ \
		Y		cept	2		1	0				
	Chipping area (ins	The standards of inner and outer chipping on edge sealing area are same. When the chipping occurred in the opposite of stage, Y as per the chipping on the non-conduction side standard in 6.3.1						ing e				
	conduct		Х		1		≤1/6L	1				
	(back si	de chipping	Υ		Y≤	1/3W	1/3W <y≤2 3w<="" td=""><td>2/3W</td><td><y< td=""><td></td><td></td><td>1</td></y<></td></y≤2>	2/3W	<y< td=""><td></td><td></td><td>1</td></y<>			1
6.3.4	Z		Aco	cept	2		2	0				
			Chi	ipping	into IT	O side	refer to 6.3.1					
	-		Х		/		≤1/8L	1				,
6.3.5	poor cut	ting and LCD	Υ		≤1,	/6W	1/6W <y≤1 5w<="" td=""><td>1/5W</td><td><y< td=""><td></td><td></td><td><b>√</b></td></y<></td></y≤1>	1/5W	<y< td=""><td></td><td></td><td><b>√</b></td></y<>			<b>√</b>

				Doc. Name		Inspection Criterion for TFT Products			Ver.		V2.3	
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		Z			/		1	1				
		Acc		cept	1		1	1				
			the	the outside protruding control as per the tolerance								
			of	of drawing.								
	Crack		No	Not allow to occur cracks without direction; the								
6.3.6		crack expand to inside is NG, but to outside is				o K						
			(co	onfirmed a	as pe	er the da	maged stand	ard)				

Remark:1)X means the length of chipping; Y means the width; Z means the thickness; W means the step width of the two glasses; H means the distance from the glass edge to the seal inner edge; t means glass thickness.

# 6.4 Backlight components

No.	Item	Description	Accepted criterion	MAJ	MIN
6.4.1	No backlight wrong Color		Rejected	<b>√</b>	
6.4.2	Color deviation	When powered on, the LCD color differs from its sample and found that the color not conforming to the drawing after testing.	Refer to sample and drawing.		√
6.4.3	Brightness deviation	When powered on, the LCD brightness differs from its sample and is found after testing not conforming to the drawing; or if it conforms to the drawing but the brightness over ±40% than its typical value.	Refer to sample and drawing.		<b>V</b>
6.4.4	Uneven brightness	Uneven on the same LCD and out of the specification of the drawing. The no specification evenness= (the max value-the min value)/ mean value< 70%.	Refer to sample and drawing.		<b>V</b>
6.4.5	Spot/line /scratch	When power on, it has dirty spot, scratches and so on spot and line defects.	Refer to 6.2.2		<b>√</b>

## 6.5 Metal frame (Metal Bezel)

No.	Item	Description	Accepted criterion	MAJ	MIN
6.5.1	Material & surface	Metal frame/surface	Rejected	2	
0.5.1	treatment	treatment do not conform to	Rejected	V	

				Doc. Name		ction Criterion FT Products	Ver.		V2.:	3
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			the spec	ifications.						
6.5.2	Tab twist Unconfo		_	Wrong twist method or direction and twist tabs are not twisted as required.				1		
6.5.3	Bezel pa	int loss	1.Front s	surface: el off and scra	atch to the					<b>√</b>
6.5.4	Bezel sc	ratch	bottom Dot:D≤0	.5mm, exceeds 3;						<b>V</b>
6.5.5	Painting discolora dent, and	•	exceeds 2.Front of with pair bottom Dot: D≤1	dent, air bubbl nt peeling off s d.0mm, exceed 0.0mm,W≤0.0	e and side cratch to the ds 3;	Rejected				<b>√</b>
6.5.6	Burr		Burr(s) on metal bezel is so long as to get into viewing area.			Rejected				<b>√</b>

6.6 FPC

No.	Item	Description	Accepted criterion	MAJ	MIN
6.6.1	Model & P/N	Material model & P/N	Keep the same with drawing and technical requirement	<b>V</b>	
6.6.2	Dimension/ position	Dimension in drawing spec  f w H  Remark: H=ITO pin length f=FPC width W=ITO pin width	f≤1/3w, h ≤1/3H, dimension in drawing spec-> OK Conducive material and ITO/PDA connective area must over than 1/2. Entire dimension must be in spec tolerance.		√
6.6.3	FPC appearance	Hot pressing material get broken, folding line open; FPC golden finger oxidate, broken ,scratch ,foreign material which cause line short	Broken length<2mm; FPC line is OK- > Accepted Crack and line broken-> Rejected		V
6.6.4	FPC burr	Burr near FPC edge area	When cover line and burr length ≤1.0mm->Accepted		<b>√</b>

				Doc. Name	Inspection Criterion for TFT Products		Ver.		V2.3	
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6.6.5	FPC fallin	ng off		C bonding area falling ; silica gel breaking		Rejected				<b>V</b>
6.6.6	Sealant missing Sealant ITO line ITO line		is not covered	l all	Rejected		<b>V</b>			
6.6.7	Missing sealant No seal		No seala	ant		Rejected		1		
6.6.8	.8 Sealant Sealant total he		height > produ ght	uct	Rejected		<b>V</b>			

## 6.7 SMT

No.	Item	Description	Accepted criterion	MAJ	MIN
6.7.1	Soldering bridge	Solder between adjacent pads and components	Rejected		<b>V</b>
6.7.2	Solder ball/splash	Solder ball/tin dross causing short circuit at the solder point. There are active solder ball and splash.	Rejected		<b>V</b>
6.7.3	Soldering excursion	Soldering slant > 1/3 soldering pad  「焊盘宽度」  「焊接宽度」	Rejected		<b>√</b>
6.7.4	Component wrong attaching	Component on PCB differs with drawing: wrong one, extra one, lack one, opposite polarity	Rejected	<b>V</b>	
		JUMP short circuit on PCB: extra soldering ,lack soldering.	Rejected	<b>V</b>	
6.7.5	Component falling off	Soldering but component is missing	Rejected	<b>V</b>	
6.7.6	Wrong component	Component model/spec differs from product specification	Rejected	1	

# 6.8 General Appearance

No.	Item	Description	Accepted criterion	MAJ	MIN
6.8.1	Dimension	According to drawing	Accepted	√	
6.8.2	Surface stain	Defect mark or label are not removed residual glue, and finger print,etc;	Rejected		1

				Doc. Name		ction Criterion FT Products	\ \/\		V2.	3
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6.8.3	Assem foreign materia	•		tain after asse nd diffuse film ly fogy stain	embly	Invisible when power on->OK Refer to 6.2.2 dot/line spec				√
6.8.4	Mixture			odel product e shipment		Rejected		<b>V</b>		
6.8.5	Produc	t mark	Missing, uno	clear, incorred d part	et,	Rejected				<b>V</b>
6.8.6	Compo	nent		mark clear, re alue in spec	esistance	Accepted (Refer to custor special requirer				<b>V</b>
6.8.7	Newtor rings	ı's	Area<1/6 so	creen area qu	antity≤1	Accepted				<b>√</b>
6.8.8	Mura		2.Naked eye	sible ->OK; vises inspection		Refer to limited samp	le			<b>√</b>
6.8.9	Light le	ak	by LCD lam 2.Judge in k (slight leaky	CD edge(near backlight) shadow LCD lamps irregular illuminate udge in black/white/gray display ght leaky is yellowish, greenish, efish ->NG);				<b>√</b>		
6.8.10	Polariz	er	over LCD e 2.No unmov in polarizer	able stain or	finger print	Accepted				<b>V</b>
6.8.11	TP defe	ect	l -	ogy&unremov verflow to VA	•	Rejected				<b>V</b>

Remark: Anything which is not clearly defined in 6.5~6.8 should refer to IPC-A-610E.Consumer Electronics, Non-consumer Electronics refer to class 1 and Industrial, Automobile refer to Class 2.

## 7. Others

Items not specified in this document or released on compromise should be inspected with reference to mutual agreement and limit samples.